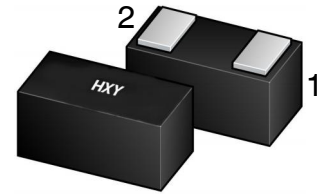




### Discription

The HESDNC5VB1GF-A protects sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD) and other voltage induced transient events. Excellent clamping capability, low leakage, low capacitance, and fast response time provide best in class protection on designs that are exposed to ESD. It gives designer the flexibility to protect one bi-directional line in applications where arrays are not practical.



DFN0603-2L

### Features

- ★ Small Body Outline Dimensions:  
0.61 mm x 0.31 mm
- ★ Low Body Height: 0.28 mm
- ★ Low Leakage
- ★ Response Time is Typically < 1 ns
- ★ ESD Rating of Class 3 (> 16 kV) per Human Bod Model
- ★ IEC61000-4-2 Level 4 ESD Protection
- ★ These are Pb-Free Devices
- ★ We declare that the material of product compliance with RoHS requirements.



Circuit Diagram

### Ordering information

Product ID	Pack	Qty(PCS)
HESDNC5VB1GF-A	DFN0603-2L	15000

### Absolute Ratings (T<sub>amb</sub>=25°C )

Symbol	Parameter	Value	Units
P <sub>PP</sub>	Peak Pulse Power (t <sub>p</sub> = 8/20μs)	80	W
T <sub>L</sub>	Maximum lead temperature for soldering during 10s	260	°C
T <sub>stg</sub>	Storage Temperature Range	-55 to +150	°C
T <sub>op</sub>	Operating Temperature Range	-40 to +125	°C
T <sub>j</sub>	Maximum junction temperature	150	°C
	IEC61000-4-2 (ESD)	air discharge contact discharge	± 30 ± 30 KV



ELECTRICAL CHARACTERISTICS

Device	$V_{RWM}$ (V)	$I_{R1}$ ( $\mu$ A) @ $V_{RWM}$	$I_{R2}$ ( $\mu$ A) @ $V_R=3.5V$	$V_{BR}$ (V) @ $I_T$ (Note 2)	$I_T$	$V_C$ (V) @ $I_{PP} = 1 A$ (Note 3)	$V_C$ (V) @ MAX $I_{PP}$ (Note 3)	$I_{PP}$ (A) (Note 3)	$P_{PK}$ (W) (Note 3)	C (pF)
	Max	Max	Max	Min	mA	Max	Max	Max	Max	Typ
HESDNC5VB1GFA	5.0	0.5	0.3	5.6	1.0	9	10	8	80	15

Other voltage available upon request.

- $V_{BR}$  is measured with a pulse test current  $I_T$  at an ambient temperature of 25°C
- Surge current waveform per Figure 1.

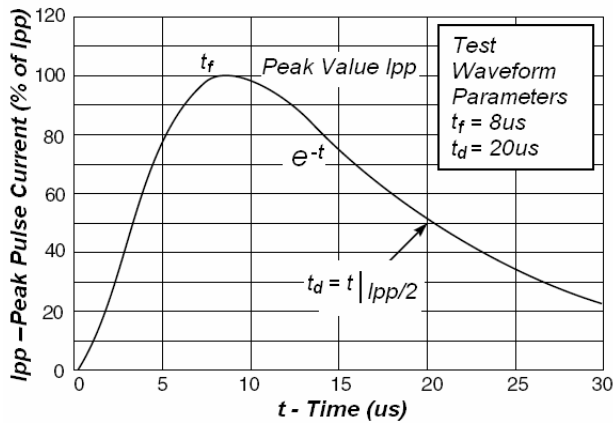


Fig1. Pulse Waveform

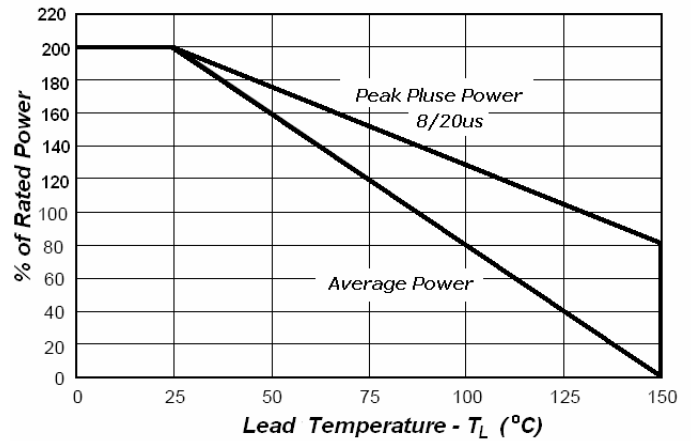
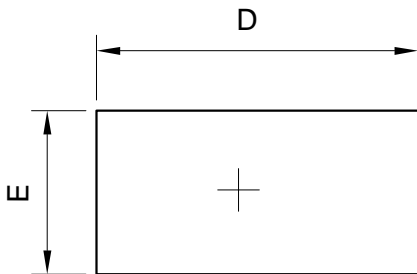


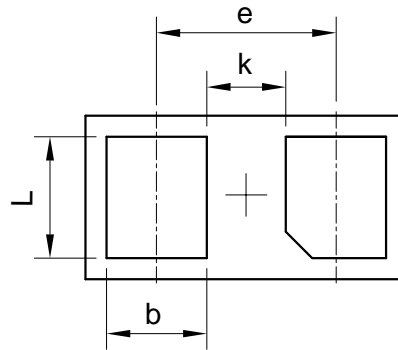
Fig2. Power Derating Curve



### Package Outline Dimension



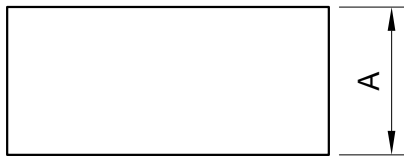
TOP VIEW



BOTTOM VIEW

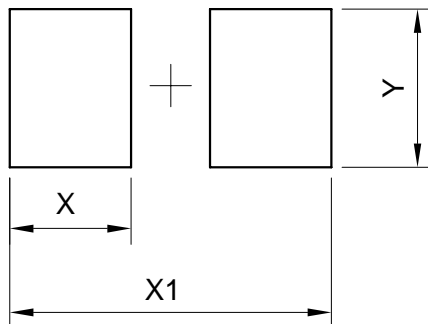
DFN0603-DL			
Dim	Min	Typ.	Max
D	0.58	0.61	0.64
E	0.28	0.31	0.34
e	-	0.34	-
L	0.20	0.23	0.26
b	0.16	0.19	0.22
A	0.25	0.28	0.31
k	0.12	0.15	0.18

All Dimensions in mm



SIDE VIEW

### Suggested Pad layout



DFN0603-DL	
DIM	(mm)
X	0.23
X1	0.61
Y	0.30



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